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Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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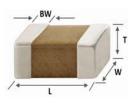


Specification of Automotive MLCC (Reference sheet)

- Supplier : Samsung electro-mechanics
- Product : Multi-layer Ceramic Capacitor
- Samsung P/N : CL05C120JB51PNC
- Description : CAP, 12pF, 50V, ± 5%, C0G, 0402
- AEC-Q200 Qualified

A. Dimension

Dimension



| Size | 0402 inch |
|------|--------------|
| L | 1.00±0.05 mm |
| W | 0.50±0.05 mm |
| Т | 0.50±0.05 mm |
| BW | 0.25±0.10 mm |

B. Samsung Part Number

| <u>CL</u> | <u>05</u> | <u>c</u> | <u>120</u> | J | <u>B</u> | <u>5</u> | <u>1</u> | <u>P</u> | <u>N</u> | <u>c</u> | |
|-----------|------------|----------|------------|--------|----------|----------|----------|----------|----------|----------|--|
| 1 | 2 | 3 | 4 | 5 | 6 | 1 | 8 | 9 | 10 | 1 | |
| Samsung | . Multi-la | wer Cer | amic Can | acitor | | | | | | | |

| ① Series | Samsung Multi-layer Ceramic Capacitor | | |
|----------------------|---------------------------------------|-----------------|-------------------------|
| ② Size | 0402 (inch code) | L: 1.00±0.05 mm | W: 0.50±0.05 mm |
| ③ Dielectric | COG | Inner electrode | Ni |
| Capacitance | 12 pF | Termination | Cu |
| ⑤ Capacitance | ± 5% | Plating | Sn 100% (Pb Free) |
| tolerance | | 9 Product | Automotive |
| 6 Rated Voltage | 50 V | Special code | Normal |
| ⑦ Thickness | 0.50±0.05 mm | ① Packaging | Cardboard Type, 7" Reel |

C. Reliability Test and Judgement condition

| | Performance | Test condition | | | |
|----------------------|--|---|--|--|--|
| l link Tonon customs | Appearance : No abnormal exterior appearance | Unpowered, 1,000hrs @ Max. temperature | | | |
| High Temperature | Capacitance Change : Within $\pm 2.5\%$ or 0.25 pF | Measurement at 24+2hrs after test conclusion | | | |
| Exposure | | | | | |
| | whichever is larger | | | | |
| | Q: 640 min. | | | | |
| | IR : More than 10,000 MΩ or 500 MΩ×μF | | | | |
| | Whichever is smaller | | | | |
| Temperature Cycling | Appearance : No abnormal exterior appearance | 1,000Cycles | | | |
| | Capacitance Change : Within ±2.5% or 0.25pF | Measurement at 24±2hrs after test conclusion | | | |
| | whichever is larger | | | | |
| | Q : 640 min. | 1 cycle condition : -55+0/-3 $^{\circ}$ C (30±3min) → Room Temp. (1min) | | | |
| | IR : More than 10,000 M $_{\Omega}$ or 500 M $_{\Omega}$ × μ F | \rightarrow 125+3/-0 °C (30±3min) \rightarrow Room Temp. (1min) | | | |
| | Whichever is smaller | | | | |
| | | | | | |
| Destructive Physical | No Defects or abnormalities | Per EIA 469 | | | |
| Analysis | | | | | |
| Humidity Bias | Appearance : No abnormal exterior appearance | 1,000hrs 85°C/85%RH, Rated Voltage and 1.3~1.5V, | | | |
| - | Capacitance Change : Within ±2.5% or 0.25pF | Add 100kohm resistor | | | |
| | whichever is larger | | | | |
| | Q : 139.96 min. | The charge/discharge current is less than 50mA. | | | |
| | IR : More than 500 MQ or 25 MQ × μ F | | | | |
| | Whichever is smaller | | | | |
| High Temperature | Appearance : No abnormal exterior appearance | 1,000hrs @ 125 °C, 200% Rated Voltage. | | | |
| Operating Life | Capacitance Change : Within ±3% or 0.3pF | Measurement at 24±2hrs after test conclusion | | | |
| | whichever is larger | The charge/discharge current is less than 50mA. | | | |
| | Q : 305 min. | | | | |
| | IR : More than 1.000 M Ω or 50 M Ω × μ F | | | | |
| | , | | | | |
| | Whichever is smaller | | | | |

| | Performance | Test condition | | | | |
|---------------------|--|--|--|--|--|--|
| External Visual | No abnormal exterior appearance | Microscope ('10) | | | | |
| Physical Dimensions | Within the specified dimensions | Using The calipers | | | | |
| Mechanical Shock | Appearance : No abnormal exterior appearance | Three shocks in each direction should be applied along | | | | |
| | Capacitance Change : Within ±2.5% or 0.25pF | 3 mutually perpendicular axes of the test specimen (18 shocks) | | | | |
| | whichever is larger | Peak value Duration Wave Velocity | | | | |
| | | 1,500G 0.5ms Half sine 4.7m/sec | | | | |
| | Q, IR : Initial spec. | | | | | |
| Vibration | Appearance : No abnormal exterior appearance | 5g's for 20min., 12cycles each of 3 orientations, | | | | |
| | Capacitance Change : Within ±2.5% or 0.25pF | Use 8"×5" PCB 0.031" Thick 7 secure points on one long side | | | | |
| | whichever is larger | and 2 secure points at corners of opposite sides. Parts mounted | | | | |
| | | within 2" from any secure point. Test from 10~2,000 $\ensuremath{\mathbb{H}_z}$. | | | | |
| | Q, IR : Initial spec. | | | | | |
| Resistance to | Appearance : No abnormal exterior appearance | preheating : 150°C for 60~120 sec. | | | | |
| Solder Heat | Capacitance Change : Within $\pm 2.5\%$ or $0.25pF$ | Solder pot : 260±5°C, 10±1sec. | | | | |
| | whichever is larger | | | | | |
| | Q, IR : Initial spec. | | | | | |
| ESD | Appearance : No abnormal exterior appearance | AEC-Q200-002 or ISO/DIS10605 | | | | |
| | Capacitance Change : Within ±2.5% or 0.25pF | | | | | |
| | whichever is larger | | | | | |
| | Q, IR : Initial spec. | | | | | |
| Solderability | 95% of the terminations is to be soldered | a) Preheat at 155 $^\circ\!\!{\rm C}$ for 4 hours, Immerse in solder for 5s at 245±5 $^\circ\!\!{\rm C}$ | | | | |
| | evenly and continuously | b) Steam aging for 8 hours, Immerse in solder for 5s at 245±5 $^\circ \!\!\! C$ | | | | |
| | | c) Steam aging for 8 hours, Immerse in solder for 120s at 260±5 $^\circ \! \mathbb{C}$ | | | | |
| | | solder : a solution ethanol and rosin | | | | |
| Electrical | Capacitance : Within specified tolerance | The Capacitance / D.F. should be measured at $25^\circ\!\mathrm{C}$, | | | | |
| Characterization | Q : 640 min. | 1 ^{Mlz} ± 10%, 0.5~5 Vrms | | | | |
| | IR(25°C): More than 100,000 M Ω or 1,000 M $\Omega \times \mu$ F | I.R. should be measured with a DC voltage not exceeding | | | | |
| | Whichever is smaller | Rated Voltage @25℃, @125℃ for 60~120 sec. | | | | |
| | $IR(125^{\circ}C)$: More than 10,000 M Ω or 100 M $\Omega \times \mu F$ | | | | | |
| | Whichever is smaller | | | | | |
| | Dielectric Strength | Dielectric Strength : 300% of the roted voltage for 1-5 accords | | | | |
| Deand Flass | Dielectric Strength | Dielectric Strength : 300% of the rated voltage for 1~5 seconds Bending to the limit, 3 mm for 60 seconds | | | | |
| Board Flex | Appearance : No abnormal exterior appearance Capacitance Change : Within ±5% or 0.5pF | Bending to the limit, 3 mm for 60 seconds | | | | |
| | | | | | | |
| | whichever is larger | 2 NL for 60 and | | | | |
| Terminal | Appearance : No abnormal exterior appearance | 2 N, for 60 sec. | | | | |
| Strength(SMD) | Capacitance Change : Within ±2.5% or 0.25pF | | | | | |
| | whichever is larger | | | | | |
| Beam Load | Destruction value should be exceed 8 N | Beam speed : 0.5±0.05 mm/sec | | | | |
| Temperature | C0G | · · · · · · · · · · · · · · · · · · · | | | | |
| Characteristics | From -55 ℃ to 125 ℃, Capacitance change should | d be within 0±30ppm/℃ | | | | |

D. Recommended Soldering method :

Reflow (Reflow Peak Temperature : 260 +0/-5 °C, 30sec.), Meet IPC/JEDEC J-STD-020 D Standard

A Product specifications included in the specifications are effective as of March 1, 2013.

Please be advised that they are standard product specifications for reference only.

We may change, modify or discontinue the product specifications without notice at any time.

So, you need to approve the product specifications before placing an order.

Should you have any question regarding the product specifications, please contact our sales personnel or application engineers.

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The products listed in this Specification sheet are **NOT** designed and manufactured for any use and applications set forth below.

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If you have any questions regarding this 'Limitation of Use and Application', you should first contact our sales personnel or application engineers.

- Aerospace/Aviation equipment
- ② Medical equipment
- *③ Military equipment*
- ④ Disaster prevention/crime prevention equipment
- *5* Power plant control equipment
- *6* Atomic energy-related equipment
- ⑦ Undersea equipment
- ⑧ Traffic signal equipment
- Data-processing equipment
- 10 Electric heating apparatus, burning equipment
- *1* Safety equipment
- 2 Any other applications with the same as or similar complexity or reliability to the applications